



March 11, 2010

### 55<sup>th</sup> Issuance of Domestic Unsecured Straight Bonds

ACOM CO., LTD. has reached a decision to make its 55<sup>th</sup> issuance of domestic unsecured straight bonds, as outlined below. The funds procured through this issuance will be used for redemption of bond maturing on April 28, 2010.

Registration relating to the issuance was carried out on July 2, 2009 and became effective as of July 10, 2009.

Name of issuance	ACOM CO., LTD. 55 <sup>th</sup> issuance of domestic unsecured straight bonds
Total value	10 billion yen
Interest rate	3.66% annually
Individual bond value	100 million yen
Issue price	Face value 100 yen
Redemption price	Face value 100 yen
Application period	March 11, 2010
Payment date	March 18, 2010
Maturation date	March 18, 2013
Application of funds procured	Redemption of bond maturing on April 28, 2010
Trustee	Mitsubishi UFJ Securities Co., Ltd. Daiwa Securities Capital Markets Co. Ltd. Nikko Cordial Securities Inc. Deutsche Securities Inc.
Transfer agent	Mitsubishi UFJ Trust and Banking Corporation
Credit ratings	Japan Credit Rating Agency, Ltd.: A
	Rating and Investment Information, Inc.: A-

---

#### ACOM CO., LTD.

Meiji Yasuda Seimei Bldg., 1-1, Marunouchi 2-chome, Chiyoda-ku, Tokyo, Japan